# 2SD2293

Silicon NPN Triple Diffused

# HITACHI

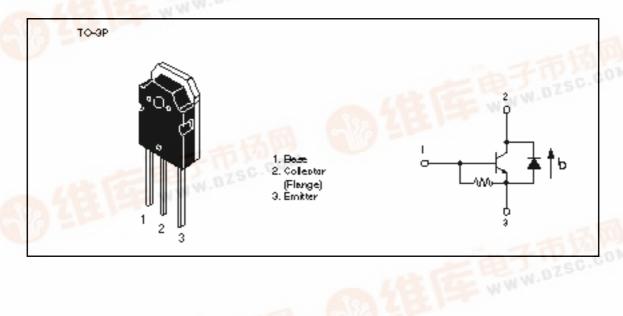
#### **Application**

CTV horizontal deflection output

#### **Features**

- High breakdown voltage  $V_{CBO} = 1500 \text{ V}$
- Built-in damper diode type

#### **Outline**





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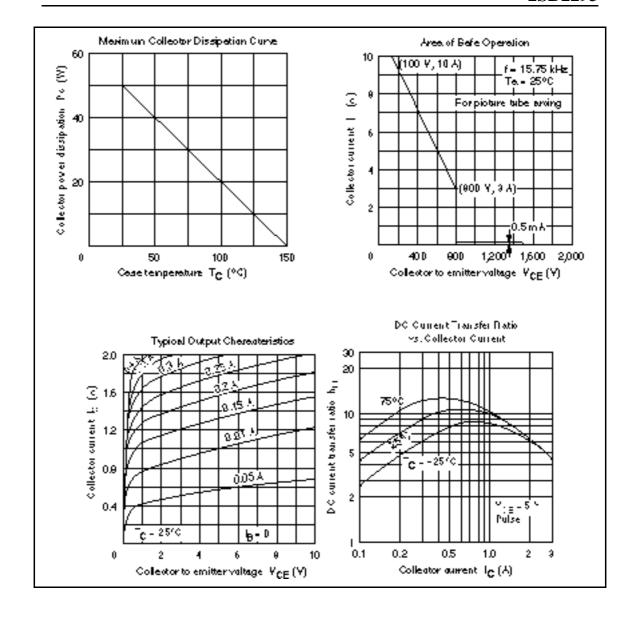
### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Ratings	Unit		
Collector to emitter voltage	V <sub>CES</sub>	1500	V		
Emitter to base voltage	$V_{EBO}$	6	V		
Collector current	I <sub>c</sub>	3	Α		
Collector peak current	I <sub>C(peak)</sub>	3.5	Α		
Collector surge current	I <sub>C(surge)</sub>	10	Α		
Collector power dissipation	P <sub>C</sub> *1	50	W		
Junction temperature	Tj	150	°C		
Storage temperature	Tstg	-55 to +150	°C		
C to E diode forward current	I <sub>D</sub>	3.5	А		

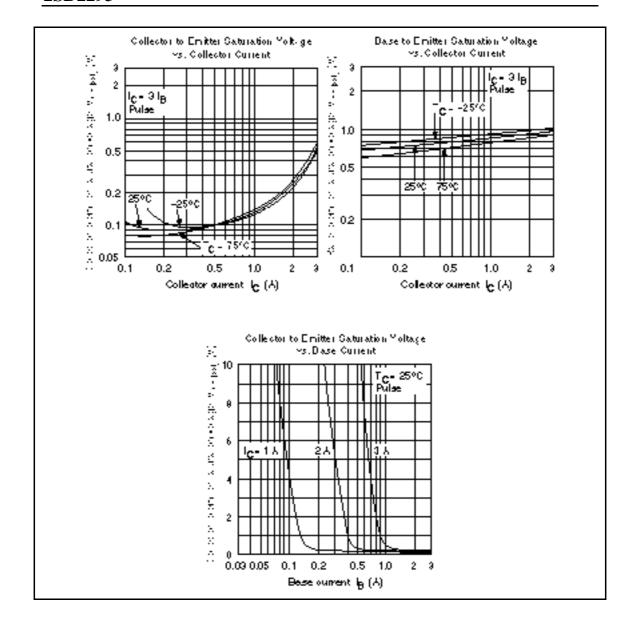
Note: 1. Value at  $T_c = 25$ °C.

## **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Emitter to base breakdown voltage	$V_{\text{(BR)EBO}}$	6	_	_	V	$I_{E} = 300 \text{ mA}, I_{C} = 0$
Collector cutoff current	I <sub>CES</sub>	_	_	500	μA	$V_{CE} = 1500 \text{ V}, R_{BE} = 0$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	5	V	$I_{\rm C} = 2.5 \text{ A}, I_{\rm B} = 0.8 \text{ A}$
Base to emitter saturation voltage	$V_{_{BE(sat)}}$	_	_	1.5	V	$I_{\rm C} = 2.5 \text{ A}, I_{\rm B} = 0.8 \text{ A}$
C to E diode forward voltage	V <sub>ECF</sub>		_	2.2	V	I <sub>F</sub> = 3 A
Fall time	t <sub>f</sub>	_	_	0.8	μs	$I_{CP} = 2.75 \text{ A}, I_{B1} = 0.6 \text{ A},$ $f_{H} = 15.75 \text{ kHz}$



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